

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Atty. Docket: NAKADA3

In re Application of:	)	Conf. No.: 7874
Tsutomu NAKADA	)	
	)	Washington, D.C.
Filed: April 2, 2004	)	
	)	
U.S. Appln. No.: 10/816,168	)	
	)	October 13, 2004
	)	
For: COPPER PLATING BATH AND	)	
PLATING METHOD	)	

**PRELIMINARY AMENDMENT**

Mail Stop Missing Parts  
Commissioner for Patents  
P.O. Box 1450  
Alexandria VA 22313-1450

Sir:

Prior to examination on the merits, and prior to  
calculation of the filing fee, kindly amend as follows:

**Amendments to the Specifications** begin on page 2 of this  
paper.

**Remarks** begin on page 4.